

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

1. (Currently amended) A backplane system comprising:
 - a first dielectric substrate;
 - a second dielectric substrate disposed generally parallel to and spaced from the first substrate; and
 - first and second conductive channels disposed between the first and second substrates, wherein the first channel is disposed along a waveguide axis, and the second channel is disposed generally parallel to and spaced from the first channel to thereby define a gap between the first and second channels along the waveguide axis,
 - wherein the first and second conductive channels are self-supporting and affixed to at least one of the first and second substrates, and
 - wherein the gap has a gap width that allows propagation along the waveguide axis of electromagnetic waves in TE $n,0$ mode, wherein n is an odd number, but suppresses electromagnetic waves in a TE $m,0$ mode, wherein m is an even number.
2. (Original) The backplane system of claim 1, wherein n is one and m is two.
3. (Original) The backplane system of claim 1, wherein
 - each said channel has a respective upper broadwall, a respective lower broadwall opposite and generally parallel to the corresponding upper broadwall, and a respective sidewall generally perpendicular to and connected to the corresponding upper and lower broadwalls;
 - the upper broadwall of the first channel and the upper broadwall of the second channel are generally coplanar; and
 - the gap is defined between the upper broadwall of the first channel and the upper broadwall of the second channel.
4. (Original) The backplane system of claim 3 wherein the lower broadwall of the first channel and the lower broadwall of the second channel are generally coplanar; and a second

gap is defined between the lower broadwall of the first channel and the lower broadwall of the second channel.

5. (Original) The backplane system of claim 1, wherein the first channel has a generally C shaped cross section along the waveguide axis.
6. (Original) The backplane system of claim 1, wherein the first channel comprises a bent sheet of electrically conductive material.
7. (Original) The backplane system of claim 1, wherein the first and second conductive channels are laminated to at least one of the first and second substrates.
8. (Original) The backplane system of claim 1, wherein the first and second conductive channels are glued to at least one of the first and second substrates.
9. (Original) The backplane system of claim 3, wherein the upper broadwalls are affixed to the first substrate, and the lower broadwalls are affixed to the second substrate.
10. (New) The backplane system of claim 1, wherein the wherein the first and second conductive channels are laminated to both of the first and second substrates.
11. (New) The backplane system of claim 1, wherein the first and second conductive channels are fabricated by extrusion or by bending a sheet of conductive material.
12. (New) A backplane system comprising:
 - a first dielectric substrate;
 - a second dielectric substrate disposed generally parallel to and spaced from the first substrate; and
 - first and second conductive channels disposed between the first and second substrates, wherein the first channel is disposed along a waveguide axis, and the second channel is disposed generally parallel to and spaced from the first channel to thereby define a gap between the first and second channels along the waveguide axis,

wherein the first and second conductive channels are glued to at least one of the first and second substrates, and

wherein the gap has a gap width that allows propagation along the waveguide axis of electromagnetic waves in TE $n,0$ mode, wherein n is an odd number, but suppresses electromagnetic waves in a TE $m,0$ mode, wherein m is an even number.

13. (New) A backplane system comprising:

a first dielectric substrate;

a second dielectric substrate disposed generally parallel to and spaced from the first substrate; and

first and second conductive channels disposed between the first and second substrates, wherein the first channel is disposed along a waveguide axis, and the second channel is disposed generally parallel to and spaced from the first channel to thereby define a gap between the first and second channels along the waveguide axis,

wherein the first and second conductive channels are affixed to at least one of the first and second substrates,

wherein the first channel comprises a bent sheet of electrically conductive material, and

wherein the gap has a gap width that allows propagation along the waveguide axis of electromagnetic waves in TE $n,0$ mode, wherein n is an odd number, but suppresses electromagnetic waves in a TE $m,0$ mode, wherein m is an even number.

14. (New) A backplane system comprising:

a first dielectric substrate;

a second dielectric substrate disposed generally parallel to and spaced from the first substrate; and

first and second conductive channels disposed between the first and second substrates, wherein the first channel is disposed along a waveguide axis, and the second channel is disposed generally parallel to and spaced from the first channel to thereby define a gap between the first and second channels along the waveguide axis,

wherein the first and second conductive channels are pre-fabricated, and

DOCKET NO.: FCI-2780/C2285B
Application No.: 10/780,835
Office Action Dated: August 27, 2004

PATENT

wherein the gap has a gap width that allows propagation along the waveguide axis of electromagnetic waves in TE $n,0$ mode, wherein n is an odd number, but suppresses electromagnetic waves in a TE $m,0$ mode, wherein m is an even number.